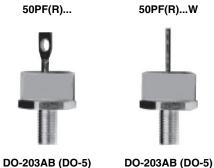


Vishay Semiconductors

# **Standard Recovery Diodes** Generation 2 DO-5 (Stud Version), 50 A



0PF(R)	50PF(R)W
7	$\perp$

PRODUCT SUMMARY		
I <sub>F(AV)</sub>	50 A	

#### **FEATURES**

- · High surge current capability
- · Designed for a wide range of applications
- · Stud cathode and stud anode version
- · Wire version available
- · Low thermal resistance
- Compliant to RoHS directive 2002/95/EC
- · Designed and qualified for multiple level

### **TYPICAL APPLICATIONS**

- Converters
- · Power supplies
- · Machine tool controls
- Welding
- · Any high voltage input rectification bridge

MAJOR RATINGS AND CHARACTERISTICS				
PARAMETER	TEST CONDITIONS	VALUES	UNITS	
		50	Α	
I <sub>F</sub> (AV)	T <sub>C</sub>	128	°C	
I <sub>F(RMS)</sub>		78	А	
I <sub>FSM</sub>	50 Hz	570	Α	
	60 Hz	595	A	
l <sup>2</sup> t	50 Hz	1600	A <sup>2</sup> s	
I-(	60 Hz	1450	A-5	
$V_{RRM}$	Range	1400 to 1600	V	
TJ		- 55 to 160	°C	

#### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS					
TYPE NUMBER	VOLTAGE CODE	V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> MAXIMUM AT T <sub>J</sub> = 150 °C mA	
50PF(R)(W)	140	1400	1650	4.5	
501 1 (11)(VV)	160	1600	1900	т.О	

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# 50PF(R)...(W) High Voltage Series

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FORWARD CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average forward current	1	190° conduct	180° conduction, half sine wave		50	Α
at case temperature	I <sub>F(AV)</sub>	160 Conduct	ion, nan sine wave		128	°C
Maximum RMS forward current	I <sub>F(RMS)</sub>				78	Α
	I <sub>FSM</sub>	t = 10 ms	No voltage	Sinusoidal half wave, initial T <sub>J</sub> = 150 °C	570	А
Maximum peak, one cycle forward,		t = 8.3 ms	reapplied		595	
non-repetitive surge current		t = 10 ms	100 % V <sub>RRM</sub>		480	
		t = 8.3 ms	reapplied		500	
	l <sup>2</sup> t	t = 10 ms	No voltage		1600	- A <sup>2</sup> s
Maximum I <sup>2</sup> t for fusing		t = 8.3 ms	reapplied		1450	
Maximum I-t for fusing		t = 10 ms	100 % V <sub>RRM</sub>		1150	
		t = 8.3 ms	reapplied		1050	
Maximum I²√t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no voltage reapplied			16 000	A²√s
Low level value of threshold voltage	V <sub>F(TO)</sub>	(16.7 % x $\pi$ x $ _{F(AV)} < I < \pi$ x $ _{F(AV)}$ ), $T_J = T_J$ maximum 0.77 V			V	
Low level value of forward slope resistance	r <sub>f</sub>	$(16.7 \% \text{ x } \pi \text{ x }  _{F(AV)} < I < \pi \text{ x }  _{F(AV)}), T_J = T_J \text{ maximum}$ 4.30 m $\Omega$			mΩ	
Maximum forward voltage drop	$V_{FM}$	$I_{pk}$ = 125 A, $T_J$ = 25 °C, $t_p$ = 400 μs rectangular wave 1.50 V			V	

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range	$T_J$ , $T_{Stg}$		- 55 to 160	°C	
Maximum thermal resistance, junction to case	$R_{thJC}$	DC operation	0.51	K/W	
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, smooth, flat and greased	0.25	r/vv	
Maximum allowable mounting torque (+ 0 %, - 10 %)		Not lubricated thread, tighting on nut (1)	3.4 (30)		
		Lubricated thread, tighting on nut (1)	2.3 (20)	N⋅m	
		Not lubricated thread, tighting on hexagon (2)	4.2 (37)	(lbf · in)	
		Lubricated thread, tighting on hexagon (2)	3.2 (28)		
Annualizations			15.8	g	
Approximate weight			0.56	OZ.	
Case style		See dimensions - link at the end of datasheet	DO-203AB (DO-5)		

#### Notes

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<sup>(1)</sup> Recommended for pass-through holes

<sup>(2)</sup> Torque must be appliable only to hexagon and not to plastic structure, recommended for holed heatsink

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△R <sub>thJC</sub> CONDUCTION					
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS	
180°	0.11	0.10			
120°	0.16	0.16			
90°	0.20	0.22	$T_J = T_J \text{ maximum}$	K/W	
60°	0.29	0.31			
30°	0.49	0.50			

#### Note

The table above shows the increment of thermal resistance R<sub>thJC</sub> when devices operate at different conduction angles than DC

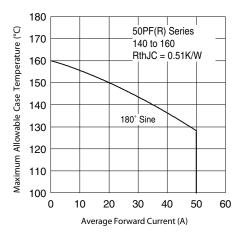


Fig. 1 - Current Ratings Characteristics

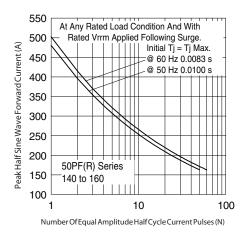


Fig. 2 - Maximum Non-Repetitive Surge Current

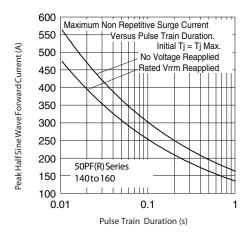


Fig. 3 - Maximum Non-Repetitive Surge Current

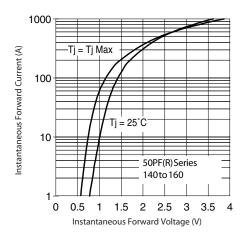


Fig. 4 - Forward Voltage Drop Characteristics

# 50PF(R)...(W) High Voltage Series

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## Standard Recovery Diodes Generation 2 DO-5 (Stud Version), 50 A



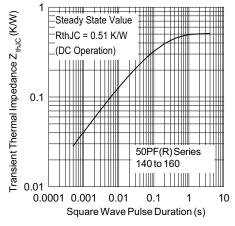
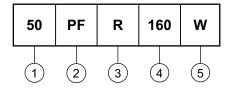


Fig. 5 - Thermal Impedance  $Z_{\text{thJC}}$  Characteristics

#### **ORDERING INFORMATION TABLE**

Device code



- 1 50 = Standard device
- PF = Plastic package
- None = Stud normal polarity (cathode to stud)
  - R = Stud reverse polarity (anode to stud)
- Voltage code x 10 = V<sub>RRM</sub> (see Voltage Ratings table)
- None = Standard terminal (see dimensions for 50PF(R)... - link at the end of datasheet)
  - W = Wire terminal (see dimensions for 50PF(R)...W - link at the end of datasheet)

LINKS TO RELATED DOCUMENTS		
Dimensions	www.vishay.com/doc?95345	

www.vishay.com

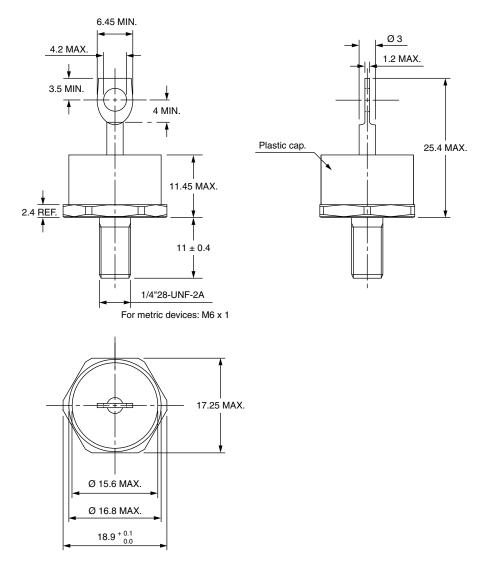
Document Number: 93517 Revision: 20-May-09



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# DO-203AB (DO-5) for 50PF(R)...(W), 80PF(R)...(W) and 95PF(R)...(W) Series

## DIMENSIONS FOR 80PF(R), 50PF(R) AND 95PF(R) SERIES in millimeters



#### Note

• For metric device please contact factory

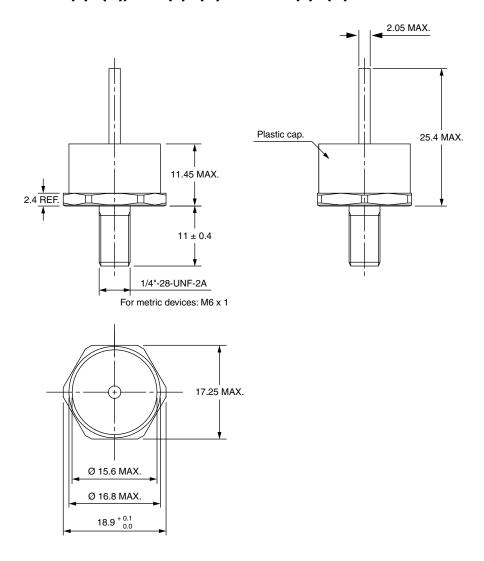
# **Outline Dimensions**

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DO-203AB (DO-5) for 50PF(R)...(W), 80PF(R)...(W) and 95PF(R)...(W) Series



## DIMENSIONS FOR 80PF(R)...(W), 50PF(R)...(W) AND 95PF(R)...(W) SERIES in millimeters



#### Note

• For metric device please contact factory

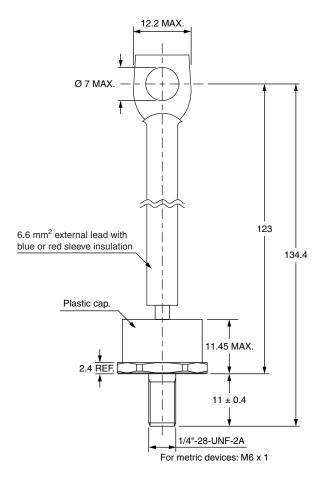
Document Number: 95345 Revision: 26-Aug-08



DO-203AB (DO-5) for 50PF(R)...(W), 80PF(R)...(W) and 95PF(R)...(W) Series

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## DIMENSIONS FOR 52PF(R), 82PF(R) AND 97PF(R) SERIES in millimeters



#### Note

• For metric device please contact factory



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